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MXB30N065J2H

650V 30A IGBT

■ Applications

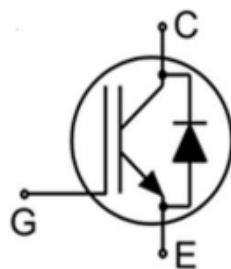
- Inverter
- Welding converters
- Power Factor Correction (PFC)
- Uninterruptible Power Supply (UPS)
- Converters with high switching frequency

■ Features

- Low $V_{CE(sat)}$
- High speed switching
- Short circuit withstand time – 5uS
- High ruggedness, temperature stable
- Positive temperature coefficient in VCE(sat)
- Enhanced avalanche capability
- RoHS and Halogen-Free Compliant

■ Product Summary

V_{CES}	650	V
I_C	30	A
$V_{CE(sat),Typ}@15V$	1.65	V



Gate: 1
Collector: 2
Emitter: 3

TO-220C

Marking	Package	Packaging	Min. package quantity
MXB30N065J2H	TO-220C	Tube	1000





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■ Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Collector-emitter Voltage	V _{CES}	650	V
DC collector current, limited by T _{jmax} TC=25°C TC=100°C	I _C	60 30	A
Pulsed collector current, tp limited by T _{jmax}	I _{C Pulse}	90	A
Diode forward current, limited by T _{jmax} TC=25°C TC=100°C	I _F	60 30	A
Diode Pulsed current, tp limited by T _{jmax}	I _{F Pulse}	90	A
Continuous Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time V _{GE} =15V, V _{CC} ≤400V, T _j ≤150°C	t _{SC}	5	μs
Power Dissipation (TC=25°C)	P _D	170	W
Junction Temperature	T _j	175	°C
Storage Temperature	T _{STG}	-55-175	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

Parameter	Symbol	Max	Unit
IGBT Maximum Junction-to-Case	R _{θJC}	0.88	°C/W
Diode Maximum Junction-to-Case	R _{θJC}	2	°C/W
Maximum Junction-to-Ambient	R _{θJA}	60	°C/W

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.





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■ Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{CES}	V _{GE} =0V, I _C =250μA	650	-	-	V
Zero gate voltage collector current	I _{CES}	V _{CE} =650V, V _{GE} =0V	-	-	20	uA
Gate-emitter leakage current	I _{GES}	V _{GE} =±20V, V _{CE} =0V	-	-	±100	nA
Gate-emitter threshold voltage	V _{GE(TH)}	V _{CE} =V _{GE} , I _C =250μA	4	5	6	V
Collector-emitter saturation voltage	V _{CE(sat)}	V _{GE} =15V, I _C =30A	-	1.65	2	V
		T _j =175°C	-	2	-	V
Diode forward voltage	V _F	I _F =30A	-	1.6	1.9	V
		T _j =175°C	-	1.3	-	V
Dynamic Characteristics						
Input Capacitance	C _{ies}	V _{CE} =25V, V _{GE} =0V, f=1.0MHz	-	1750	-	pF
Output Capacitance	C _{oes}		-	75	-	pF
Reverse Transfer Capacitance	C _{res}		-	28	-	pF
Integrated gate resistor	R _{Gint}		-	6	-	Ω
Total Gate Charge	Q _g	V _{CC} =400V, I _C =30A, V _{GE} =15V	-	63.5	-	nC
Gate-to-emitter charge	Q _{ge}		-	13.5	-	nC
Gate-to-collector charge	Q _{gc}		-	23	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L _E		-	7	-	nH





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■ Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
IGBT Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}=400\text{V}, I_C=30\text{A}, V_{GE}=0/15\text{V}, R_g=10\Omega$ Inductive load	-	28	-	ns
Turn-On Rise Time	t_r		-	40	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	88	-	ns
Turn-Off Fall Time	t_f		-	149	-	ns
Turn-on energy	E_{on}		-	0.89	-	mJ
Turn-off energy	E_{off}		-	0.41	-	mJ
Body Diode Characteristics						
Reverse Recovery Time	t_{rr}	$V_R=400\text{V}, I_F=30\text{A}, di/dt=100\text{A/us}$	-	20	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.12	-	μC
Peak Reverse Recovery Current	I_{rrm}		-	12	-	A

■ Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
IGBT Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}=400\text{V}, I_C=30\text{A}, V_{GE}=0/15\text{V}, R_g=10\Omega$ Inductive load	-	32	-	ns
Turn-On Rise Time	t_r		-	40	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	78	-	ns
Turn-Off Fall Time	t_f		-	184	-	ns
Turn-on energy	E_{on}		-	1.18	-	mJ
Turn-off energy	E_{off}		-	0.65	-	mJ
Body Diode Characteristics						
Reverse Recovery Time	t_{rr}	$V_R=400\text{V}, I_F=30\text{A}, di/dt=100\text{A/us}$	-	83	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.6	-	μC
Peak Reverse Recovery Current	I_{rrm}		-	15	-	A

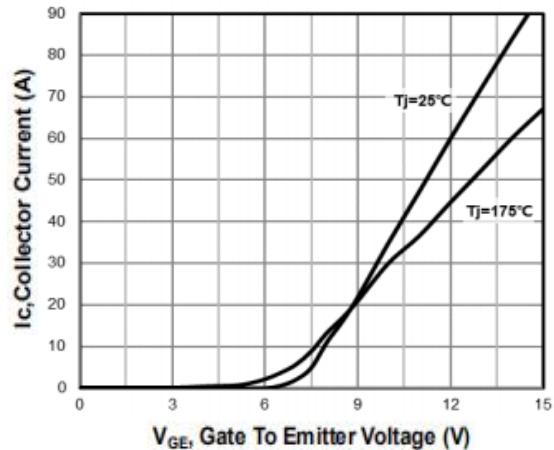
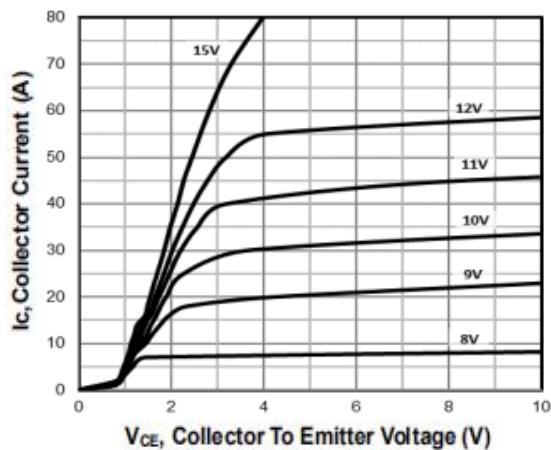




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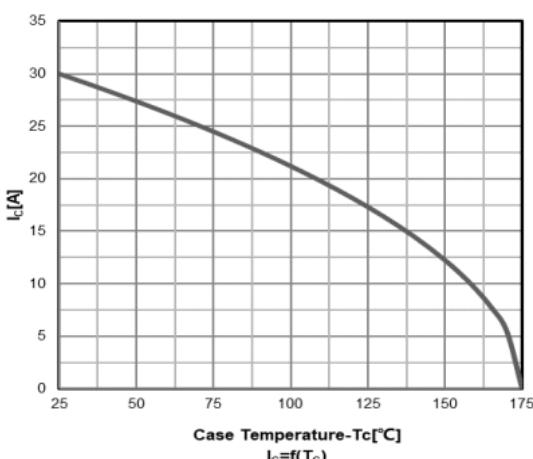
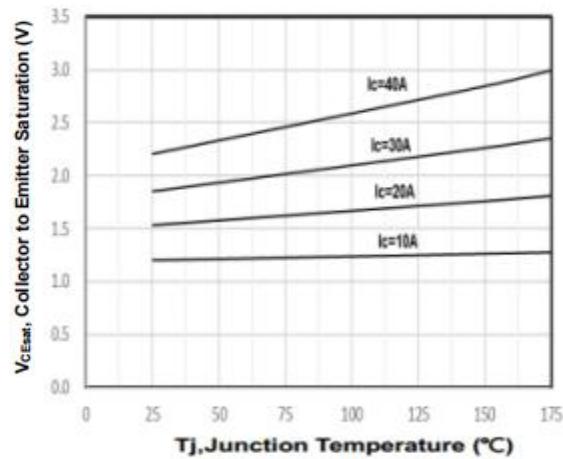
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■ Characteristics Curves

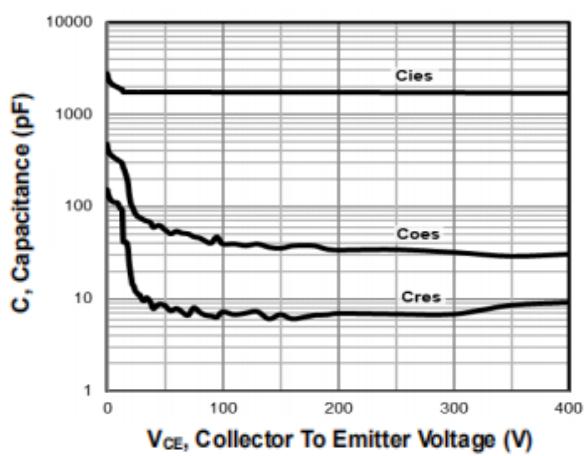


Output Characteristics

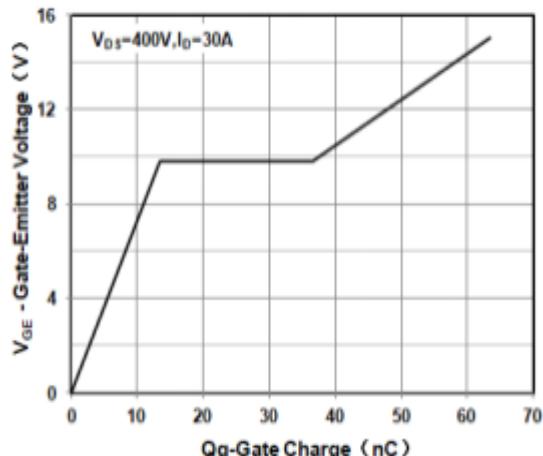
Transfer Characteristics

Typical collector-emitter saturation voltage as a function of junction temperature ($V_{GE} = 15V$)

Collector current as a function of Case temperature



Capacitance



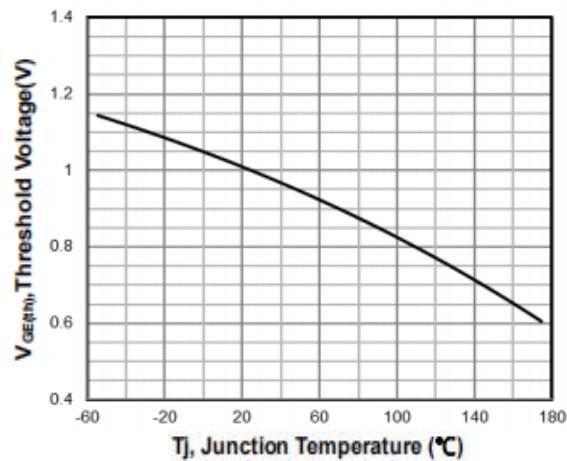
Typical gate charge



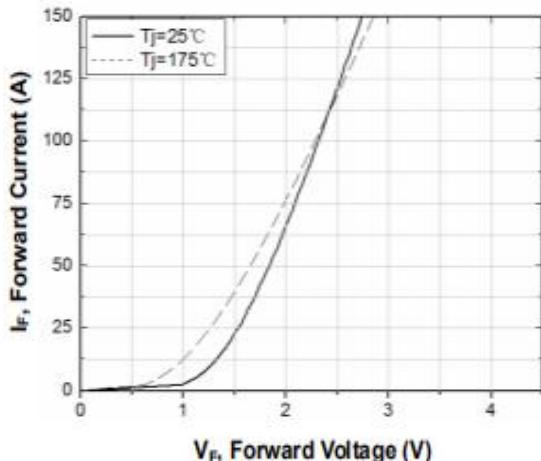


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Gate-emitter threshold voltage as a function of junction temperature



Typ. diode forward current as a function of forward voltage

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





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■ TO-220C Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	4.3		4.8	e	2.44	2.54	2.64
B	1.2		1.4	F	1.2		1.45
B1	1		1.4	L	12.75		13.9
b1	0.7		0.95	L1	2.85		3.4
c	0.4		0.65	ΦP	3.5		3.8
D	15.2		16	Q	2.6		3
D1	6.2		6.8	Q1	2.2		2.7
E	9.7		10.3				

